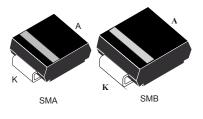


STPS1H100-Y

Datasheet

Automotive high voltage power Schottky rectifier





Features

- AEC-Q101 qualified
- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK[®]2 compliant component
- PPAP capable
- V_{RRM} guaranteed from -40°C to +175°C

Description

Schottky rectifiers packaged in SMA or SMB, and designed for high frequency miniature switched mode power supplies as DC/DC converters for automotive applications. It is particularly suited for LED lighting applications, ADAS power, and ECU (Engine Control Unit) in automotive environment.

Product status			
STPS1H100-Y			
Product summary			
Symbol Value			
I _{F(AV)}	1 A		
V _{RRM}	100 V		
T _j (range)	-40 °C to +175 °C		
V _{F(max.)}	0.62 V		

1 Characteristics

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Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak reverse voltage, T _j = -40 °C to +175 °C		100	V	
I _{F(RMS)}	Forward rms current		10	Α	
	As a reaction of the second statement $\Sigma = 0.5$	SMA	T _L = 150 °C	4	A
I _{F(AV)}	Average forward current, $\delta = 0.5$	SMB	T _L = 155 °C	1	
I _{FSM}	Surge non repetitive forward current		t _p = 10 ms sinusoidal	50	Α
P _{ARM}	Repetitive peak avalanche power		t _p = 10 μs, T _j = 125 °C	108	W
T _{stg}	Storage temperature range		-65 to +175	°C	
Тj	Maximum operating junction temperature ⁽¹⁾		+175	°C	

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

1. $(dP_{tot'}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal parameters

	Symbol	Parameter		Max. value	Unit
	R _{th(j-l)} Junction to lead	lunction to load	SMA	30	°C/W
			SMB	25	C/W

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage	Poveraa lookago eurrant	T _j = 25 °C	V _R = V _{RRM}	-		4	μA
'R' '	Reverse leakage current	T _j = 125 °C		-	0.2	0.5	mA
		T _j = 25 °C	I _F = 1 A	-		0.77	
N (2)		T _j = 125 °C		-	0.58	0.62	
V _F ⁽²⁾	Forward voltage drop	$T_j = 25 \degree C$	1 - 2 A	-		0.86	V
		T _j = 125 °C	– I _F = 2 A	-	0.65	0.70	

1. Pulse test: tp = 5 ms, $\delta < 2\%$

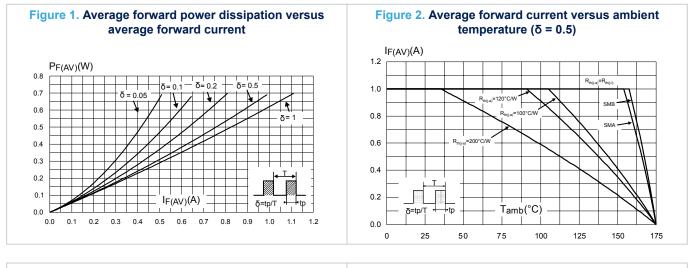
2. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses, use the following equation:

 $P = 0.54 \text{ x } I_{F(AV)} + 0.08 \text{ x } I_{F}^{2}(RMS)$



1.1 **Characteristics (curves)**



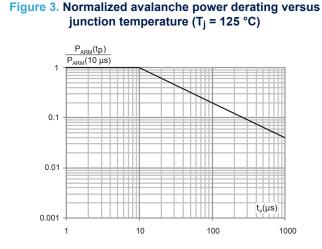
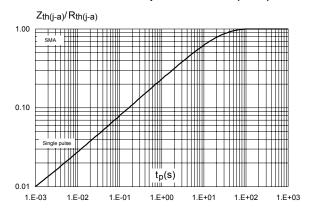
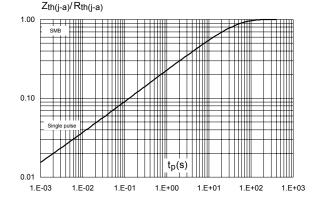
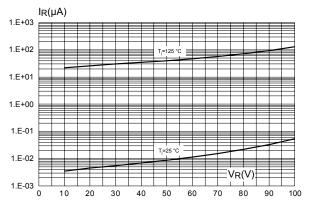


Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration (SMA)





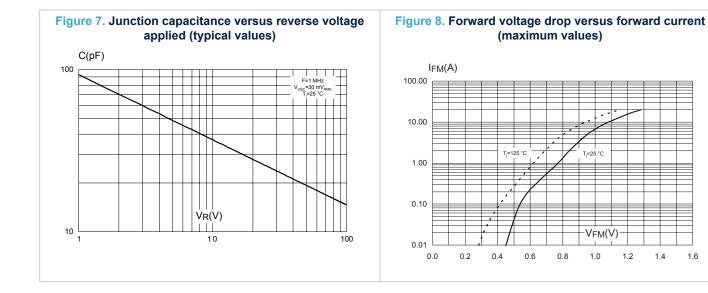






1.4

1.6



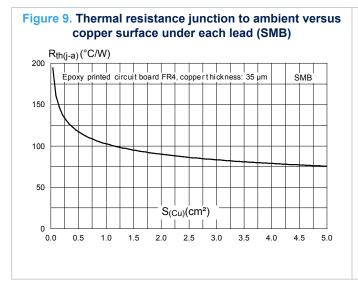
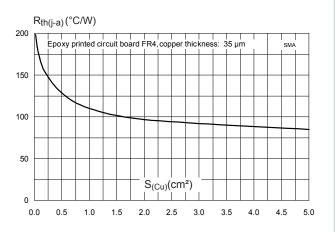


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead (SMA)



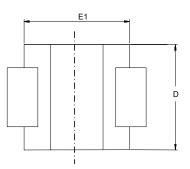
2 Package information

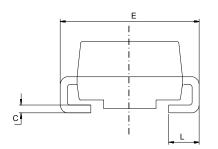
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

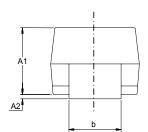
2.1 SMB package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 11. SMB package outline



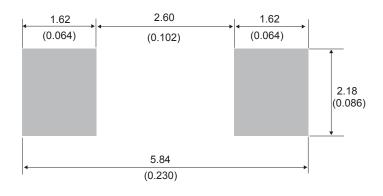




	Dimensions				
Ref.	Millin	Millimeters		nes	
	Min.	Max.	Min.	Max.	
A1	1.90	2.45	0.0748	0.0965	
A2	0.05	0.20	0.0020	0.0079	
b	1.95	2.20	0.0768	0.0867	
С	0.15	0.40	0.0059	0.0157	
D	3.30	3.95	0.1299	0.1556	
E	5.10	5.60	0.2008	0.2205	
E1	4.05	4.60	0.1594	0.1811	
L	0.75	1.50	0.0295	0.0591	

Table 4. SMB package mechanical data

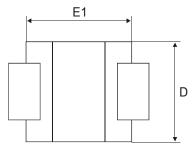
Figure 12. SMB recommended footprint

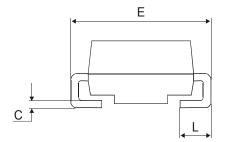


2.2 SMA package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 13. SMA package outline





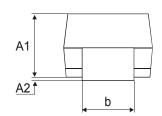
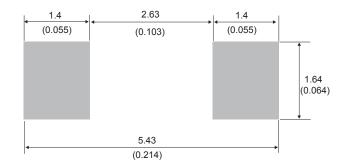


Table 5. SMA package mechanical data

		Dim	ensions	
Ref.	Milli	Millimeters		hes
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.097
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
С	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059





3 Ordering Information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS1H100AY	S11Y	SMA	0.068 g	5000	Tape and reel
STPS1H100UY	G11Y	SMB	0.107	2500	Tape and Teer

Table 6. Ordering information

Revision history

Table 7	7. Document	revision	history
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Date	Version	Changes
3-Dec-2010	1	Initial release.
10-Apr-2018	2	Update Figure 3 "Normalized avalanche power derating versus pulse duration" with P_{ARM} 10 μs curve.



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